### molex

## Mini-Lock Wire-to-Board Connector System >

The versatile and proven 2.50mm pitch Mini-Lock Wire-to-Board/Wire-to-Wire Connector system extends design options to include vertical and right-angle SMT headers, with terminal position assurance (TPA) retainer and Glow-Wire through-hole vertical header options

#### **FEATURES AND ADVANTAGES**



#### **Terminal Position Assurance (TPA)**

Ensures that wires are fully inserted

Receptacle Housing: 51163 TPA: 51164

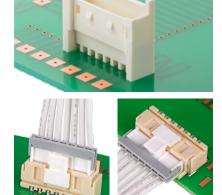


#### **Locating Peg (Boss)**

Mitigates the misalignment by assisting in right mount orientation

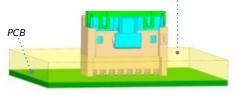


Provide secure header retention on the PCB before soldering



### Potting treatment (Height 2.00 to 6.00mm)

Protects the components on PCB from dust and water



Header for Potting: 53517xx30

### Terminal Position Assurance feature

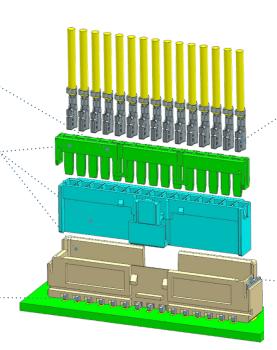
Seats the crimp terminal fully in the receptacle housing to reduce terminal backout

#### **Glow Wire compliance**

Meets global safety and environmental requirements

#### **SMT Header Terminals**

Allow quick, automated mounting assembly on the PCB when used as a vertical header



Series 215931 SMT Vertical Header 2 to 15 circuits

#### **Use of Popular Crimp Terminals**

Enables easy access to crimp applicators that are readily available in the market



#### **SMT Solder Tabs**

Enable robust retention on the PCB when mounted as a rightangle header (in which case a different series number, 215932 is assigned)



## Mini-Lock Wire-to-Board Connector System >

#### **APPLICATIONS**

#### **Home Appliance**

Refrigerators Washers and dryers Air conditioners

#### **Industrial**

Automation equipment Vending machines

#### **Consumer**

Fitness equipment Gaming machines Security systems

#### **Automotive**

Interior/exterior lightings Audio equipment Navigation systems







Refrigerators



Vending Machines

#### **SPECIFICATIONS**

#### **REFERENCE INFORMATION**

Packaging: Refer to Packaging Specifications

UL File No.: E29179 CSA File No.: LR19980 Designed In: Millimeters

RoHS: Yes Halogen Free: No

Glow Wire Compliant: Yes

#### **ELECTRICAL**

Voltage (max.): 250V Current (max.):

Refer to Current Derating Reference Information Contact Resistance (max.): 20 milliohms Dielectric Withstanding Voltage: 1000V AC/ min Insulation Resistance (min.): 1000 Megohms

#### **MECHANICAL**

Contact Insertion Force (max.): 9.8N Contact Retention to Housing (min.): 14.7N Mating Force (max.): 58.8N (8 circuit) Unmating Force (min.): 7.9N (8 circuit)

Durability (max.): 30 cycles

#### PHYSICAL

Housing:

PBTP UL94V-O (51163, 51164, 53375, 53426)

PA66 UL94V-O (53517)

PA9T UL94V-0 (215931, 215932)

Contact: Phosphor Bronze

Plating: Pre-Tin

Contact Area (min.)- 0.9 micrometer

Header Pin: Phosphor Bronze

Plating: Pre-Tin

Contact Area (min.) - 1.0 micrometer Operating Temperature: -40 to+ 105°C



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#### **CURRENT DERATING REFERENCE INFORMATION**

AWG	2-circuits	7-circuits	15-circuits
	Amps (A)	Amps (A)	Amps (A)
20	5.0	3.5	3.5
22	4.5	3.0	3.0
24	4.0	2.5	2.5
26	3.5	2.5	2.0

- (1) Values are for REFERENCE ONLY.
- (2) Current derating values are based on temperatures not exceeding 30°C.
- (3) PCB trace design can greatly affect temperature rise results in wire-to-board applications.
- (4) Data is for all powered circuits.
- (5) All data are interpolated information.

#### **ORDERING INFORMATION**

Series No.	Components	AWG or Circuits	Glow Wire Compliant
<u>50752</u>	Crimp Terminal	20 to 26 AWG	-
<u>51163</u>	Receptacle Housing	2 to 15	Yes
<u>51164</u>	TPA Retainer		Yes
<u>53517</u>	Vertical Header for Potting, H=17.5mm,Through Hole		Yes
<u>53375</u>	Vertical Header, H=11.5mm, Through Hole		No
<u>53476</u>	Vertical Header, H=11.5mm, Through Hole		Yes
<u>53426xx10</u>	Right Angle Header, Through Hole		No
<u>534269xx0</u>	Right Angle Header, Through Hole		Yes
<u>215931</u>	Vertical Header, SMT		Qualification in process
215932	Right Angle Header, SMT		Qualification in process